



J.A.M.E.S.

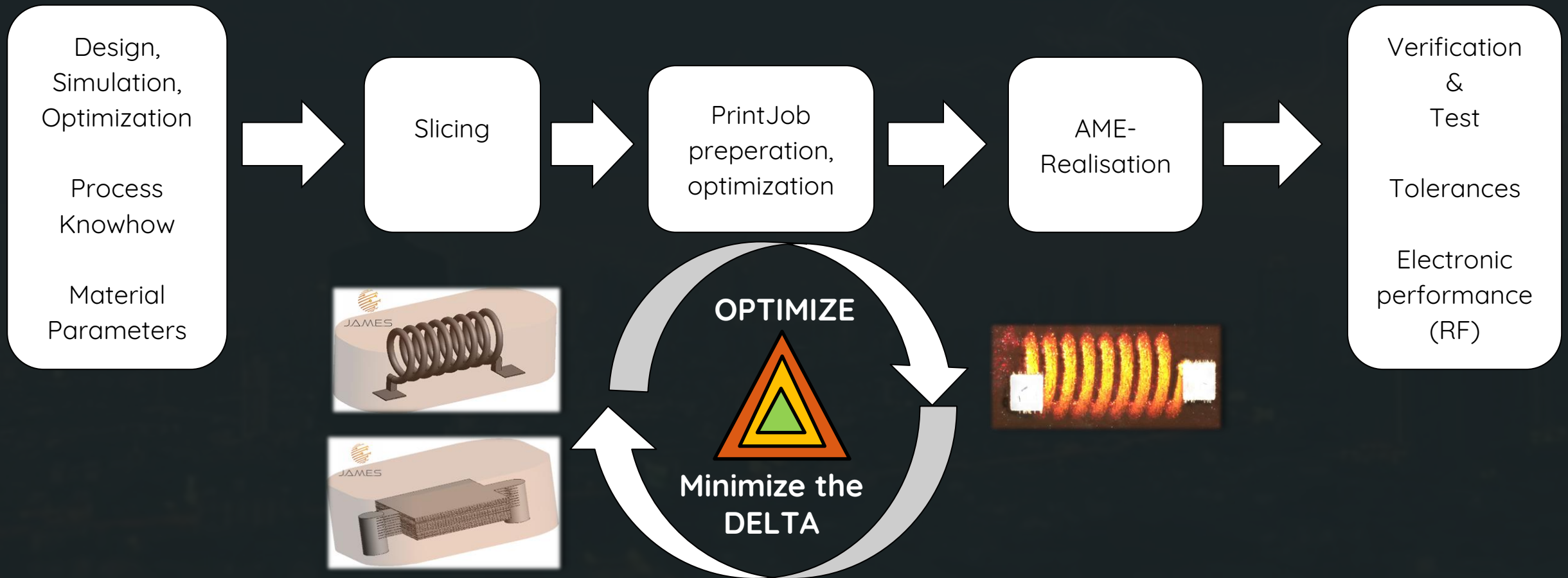
AME

Coils and Caps Test Coupon

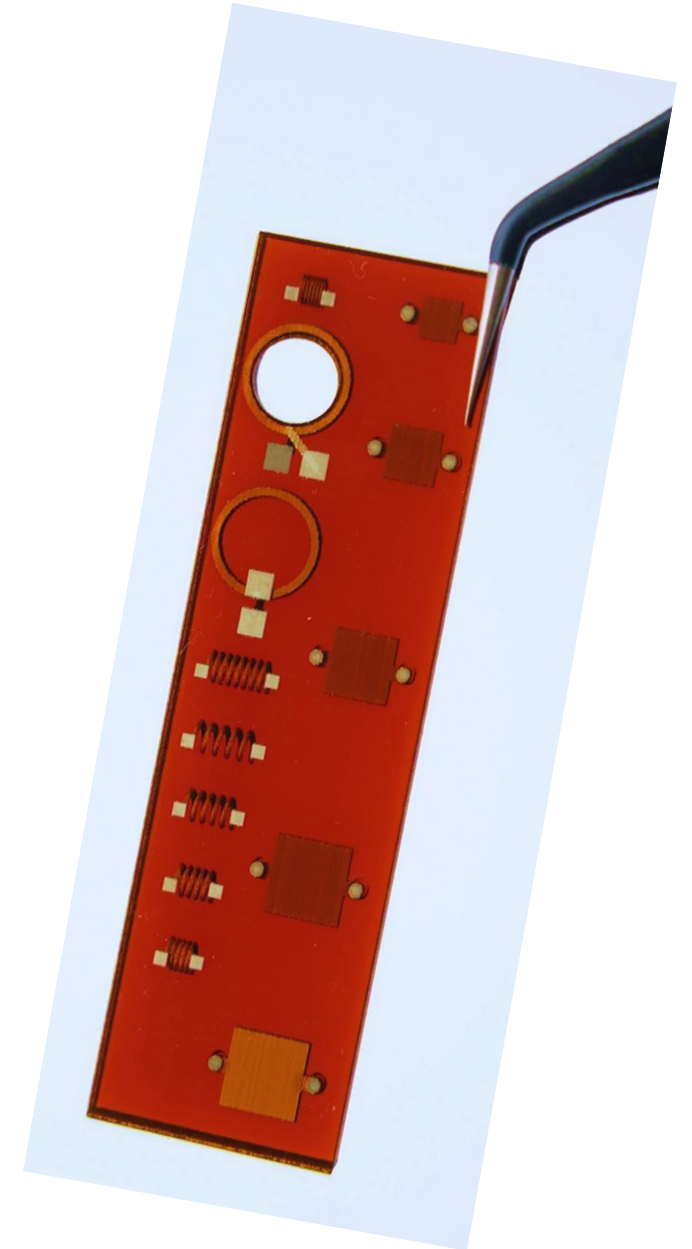
Single Elements
J.A.M.E.S. engineering

AME-Elements Workflow with optimization

- from Simulation to full optimized & functional electronics
 - Without tuning manually

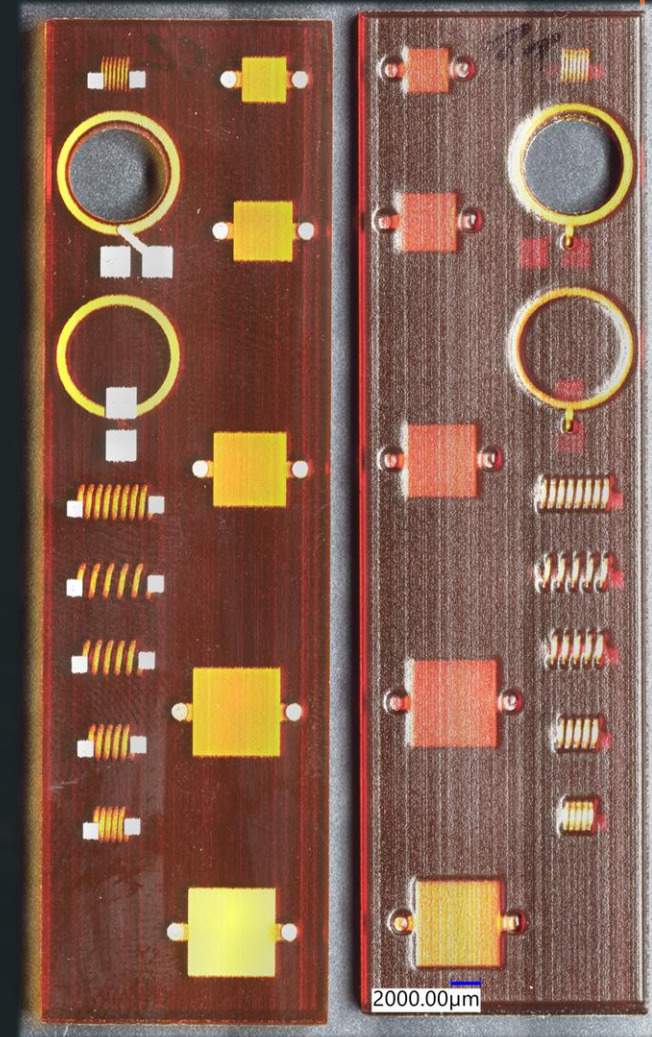
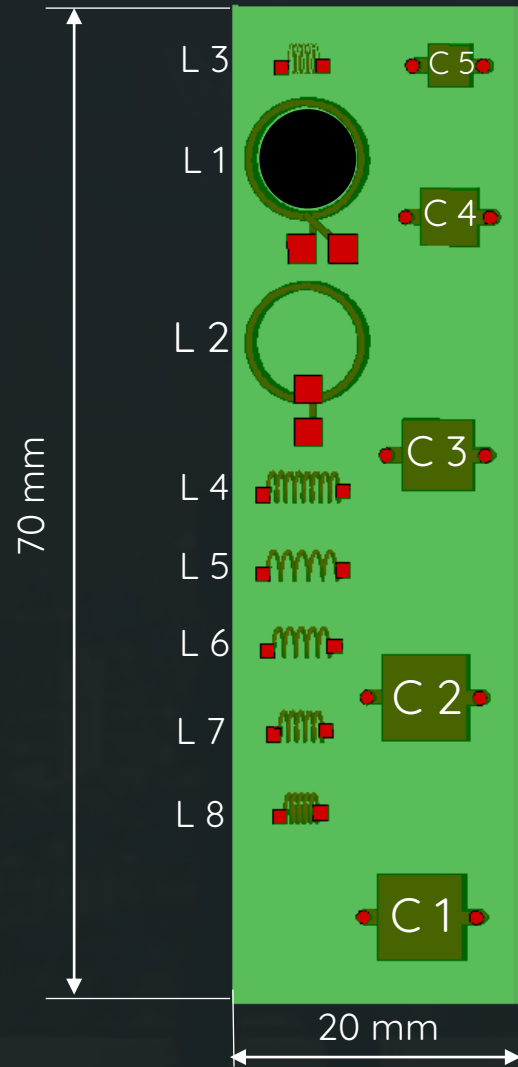


Inside the Coils and Caps coupon-Design



Coils and Caps Coupon





- Design Insights of all single elements in the coupon sample

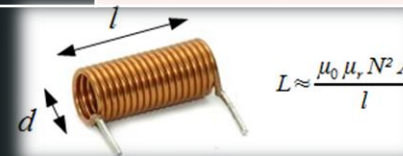


Coils and Caps Coupon

- Examples for 3D-Coil-Design variations




AME-Coil	comments
L1 	Air filled
L2 	DI filled
L3 	d = 2.2mm, l = 2.1 mm N = 7; wires 0.1 mm
L4 	d = 3mm, l = 5.2 mm N = 8; wires 0.3 mm

AME-Coil	comments
L5 	d = 2.2mm, l = 5.4 mm N = 8; wires 0.3 mm
L6 	d = 2.2mm, l = 4.2 mm N = 5; wires 0.3 mm
L7 	d = 2.2mm, l = 3.4 mm N = 5; wires 0.3 mm
L8 	d = 3mm, l = 2.5 mm N = 5; wires 0.3 mm

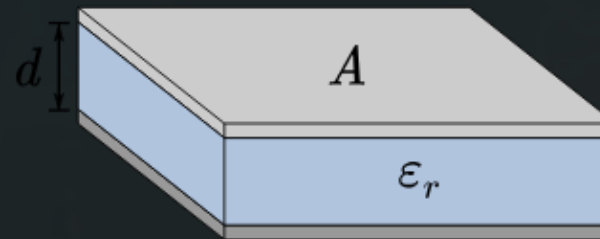


Coils and Caps Coupon

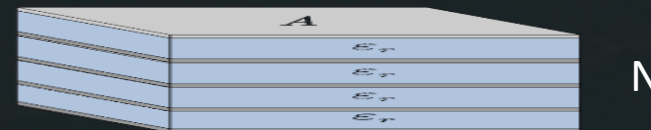
- Examples for 3D-Capacitor-Design variations

AME-Cap	comments
C5 	6x6 mm 36 plates, 1 mm thick
C4 	6x6 mm 18 plates 2 mm thick
C3 	5x5 mm 18 plates 1 mm thick
C2 	4x4 mm 18 plates 1 mm thick
C1 	3x3 mm 18 plates 2 mm thick

$$C = \epsilon_0 \epsilon_r \frac{A}{d}$$

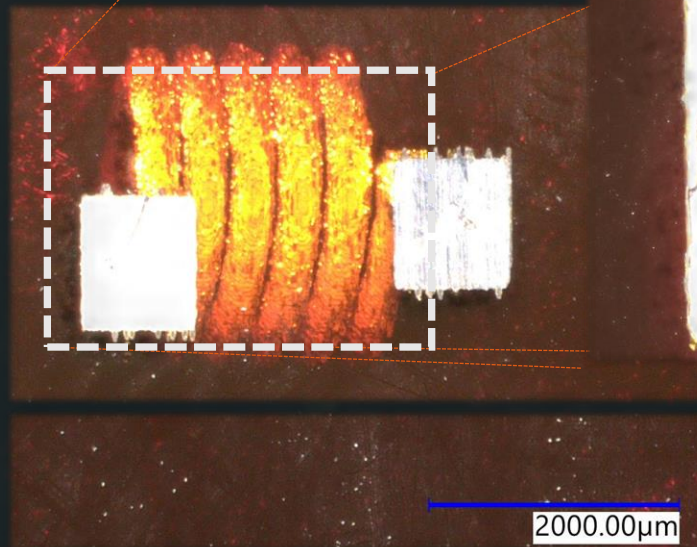
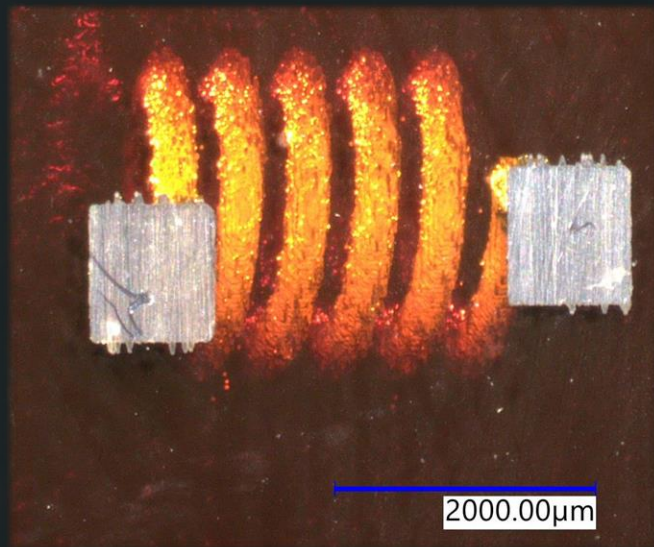


$$C = \epsilon_0 \epsilon_r (N - 1) \frac{A}{d}$$

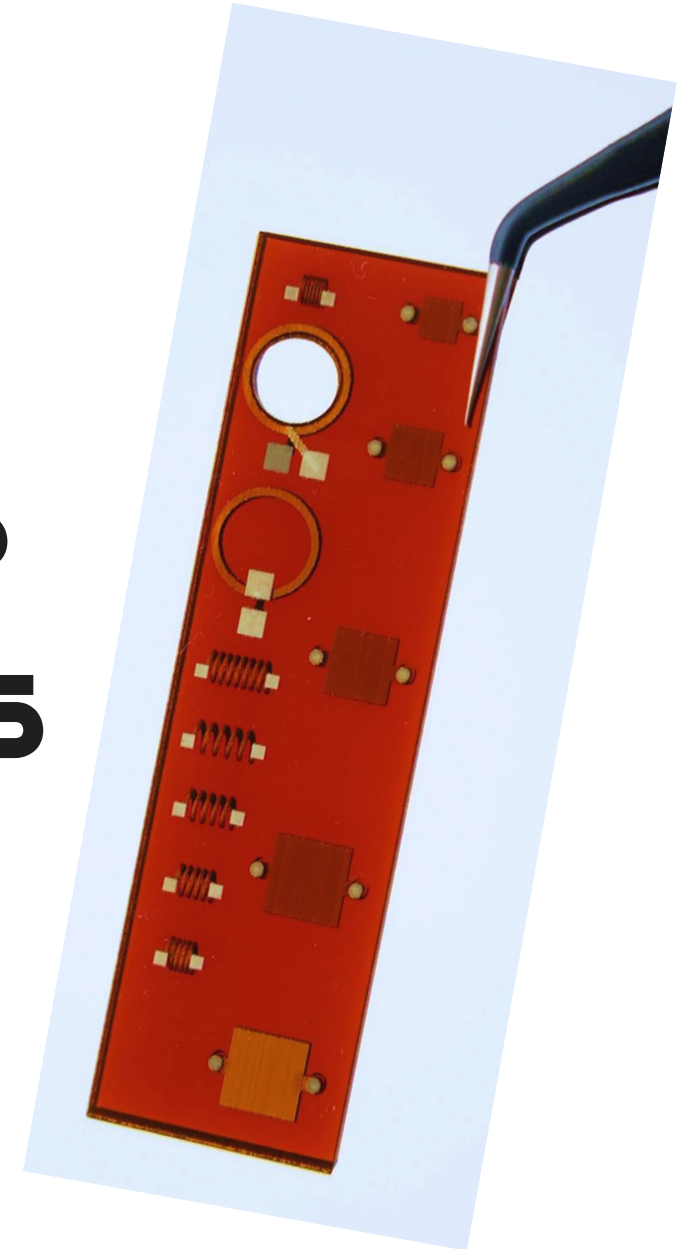


Coils and Caps Coupon

- Deep insights
- High z-axis conductivity relevance



Measuring results For Coils and Caps coupon-Design



Coils and Caps Coupon - measured

Measurement results (with LCR Bridge)






- Verification method different by usecase and frequency

AME-Coil	Measurement [μH] @100 kHz
L1 	3,4 μH
L2 	3,4 μH
L3 	not verified
L4 	8 μH
<i>Verification ongoing as KPI for printing process</i>	

AME-Coil	Measurement [μH] @ 100 kHz
L5 	8 μH
L6 	7 μH
L7 	7 μH
L8 	7 μH
<i>Verification ongoing as KPI for printing process</i>	

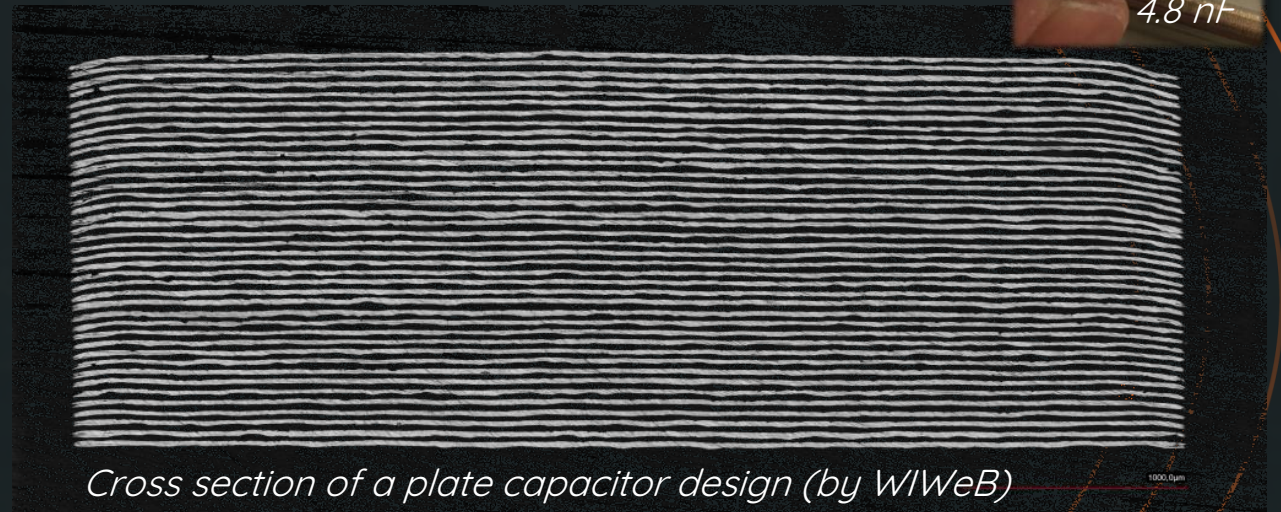
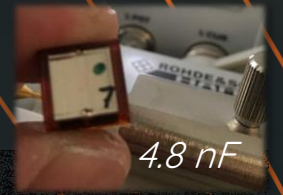
Coils and Caps Coupon - measured

- Measurement for 3D-Coil-Design variations
- Verification method different by usecase and frequency

AME-Cap	Measurement [pF] @100 kHz
C5 	185 pF
C4 	325 pF
C3 	510 pF
C2 	730 pF
C1 	1420 pF

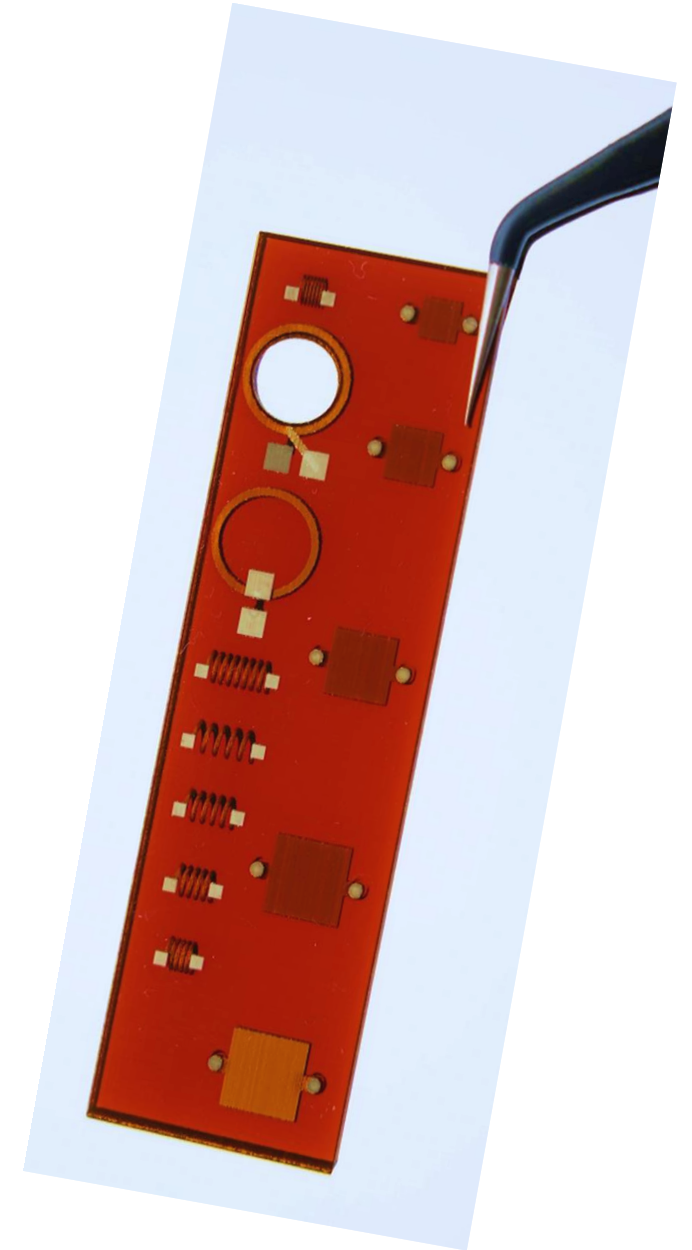


Measurement with LCR Bridge



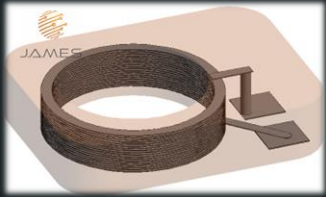
Cross section of a plate capacitor design (by WIWeB)

Single Coils and Caps Samples From Coupon-Design

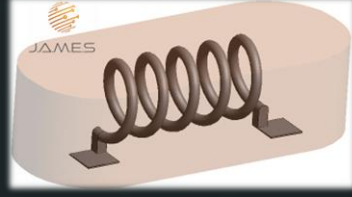


Coils and Caps single Coupon samples

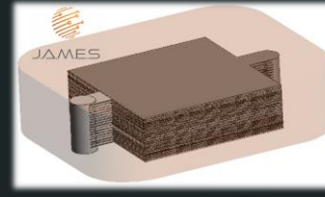
- Digital designs to implement in your design (simulated with epsilon r = 2,79)



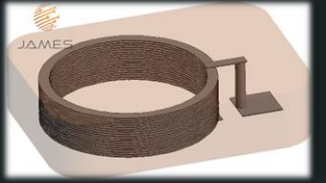
L1
3.15 μ H



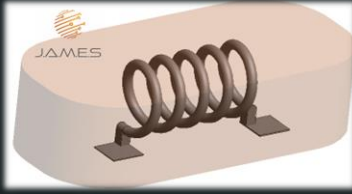
L5
23nH



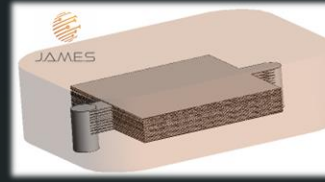
C1
171 pF



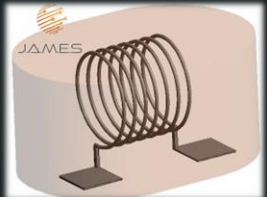
L2
3.13 μ H



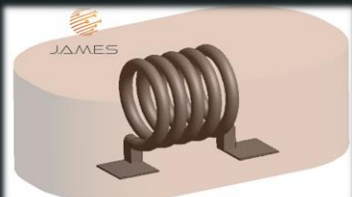
L6
23nH



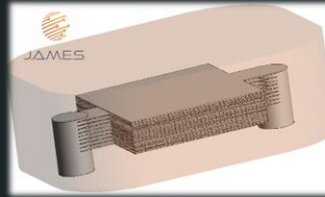
C2
462 pF



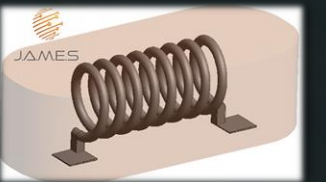
L3
76nH



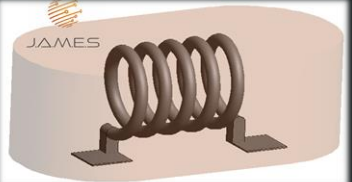
L7
25nH



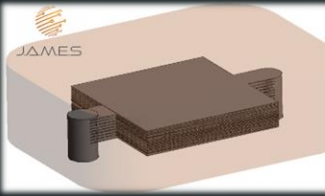
C3
299pF



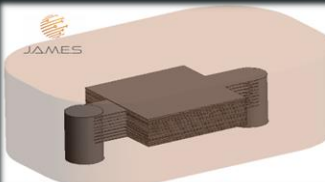
L4
42nH



L8
27nH

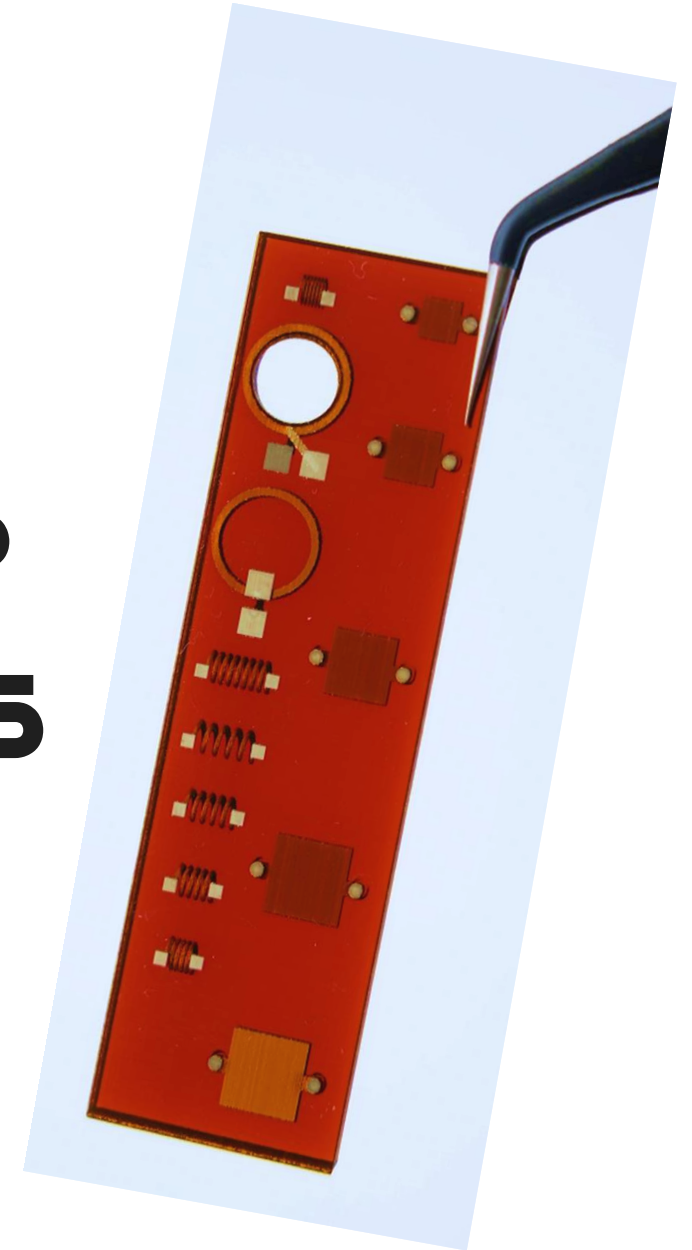


C4
661 pF



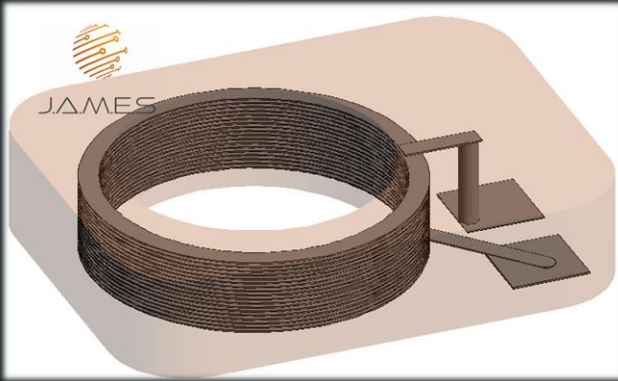
C5
1.35 nF

Simulation results For Coils and Caps coupon-Design



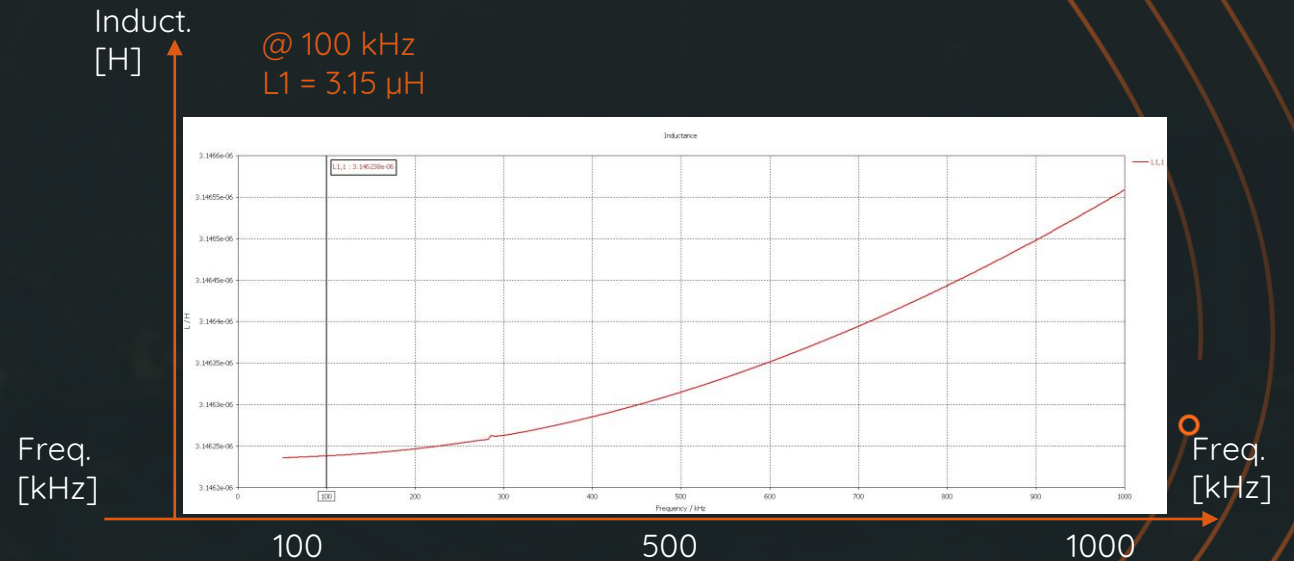
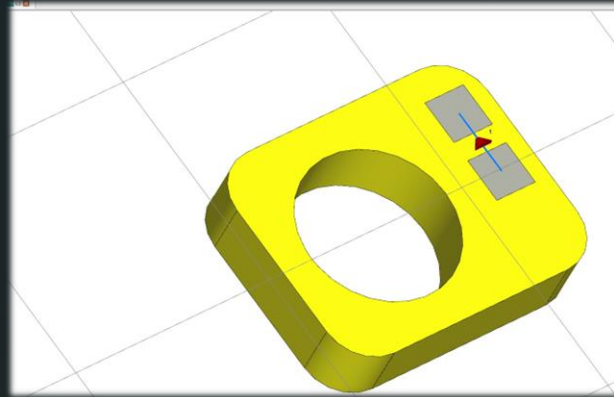
Coils and Caps single Coupon samples

- Example for one AME-Coil L1



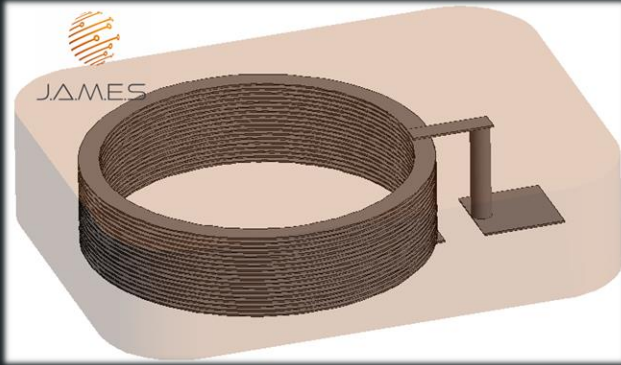
L1 = 3.15 μ H
Measured 3.5 μ H

- CST-Model for Simulation



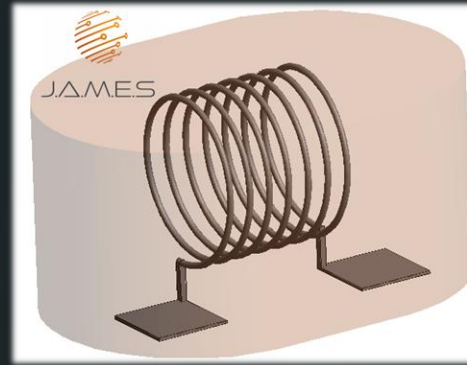
Coils and Caps single Coupon samples

- Example for one AME-Coil L2



L2 = 3.13 μ H
Measured 3.6 μ H

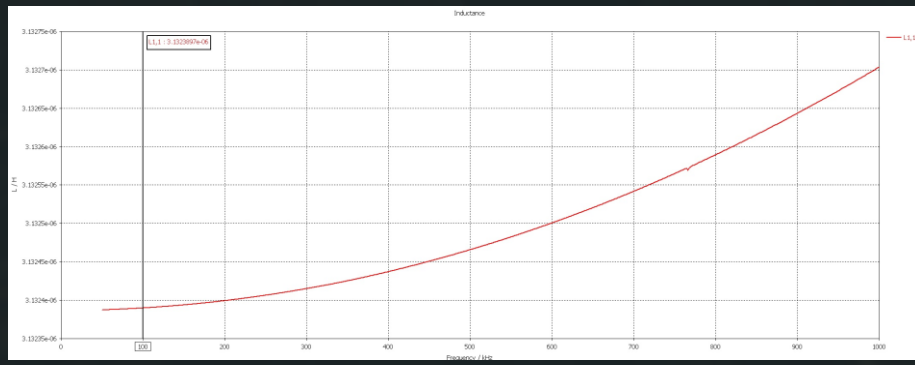
- Example for one AME-Coil L3



L3 = 76 nH
Not verified

Induct.
[H]

@ 100 kHz
L2 = 3.13 μ H



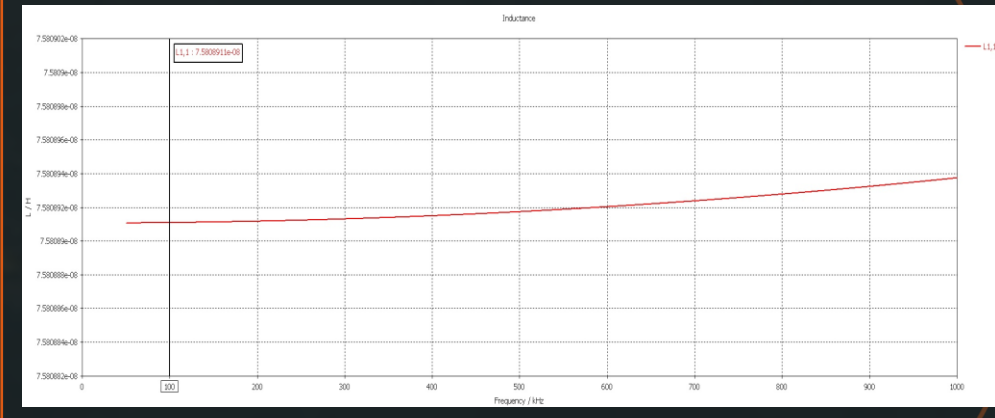
100

500

1000

Induct.
[H]

@ 100 kHz
L3 = 76 nH



100

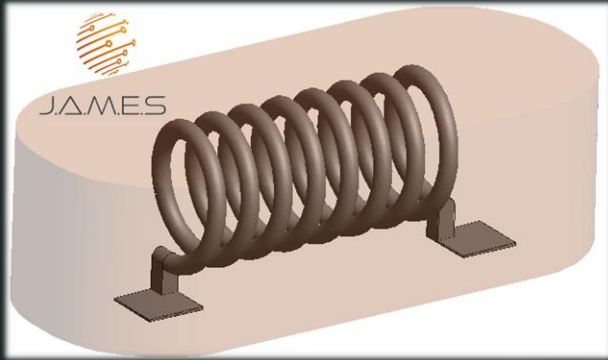
500

1000

Freq.
[kHz]

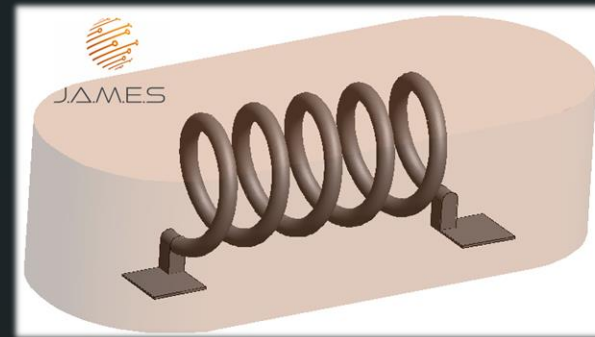
Coils and Caps single Coupon samples

- Example for one AME-Coil L4

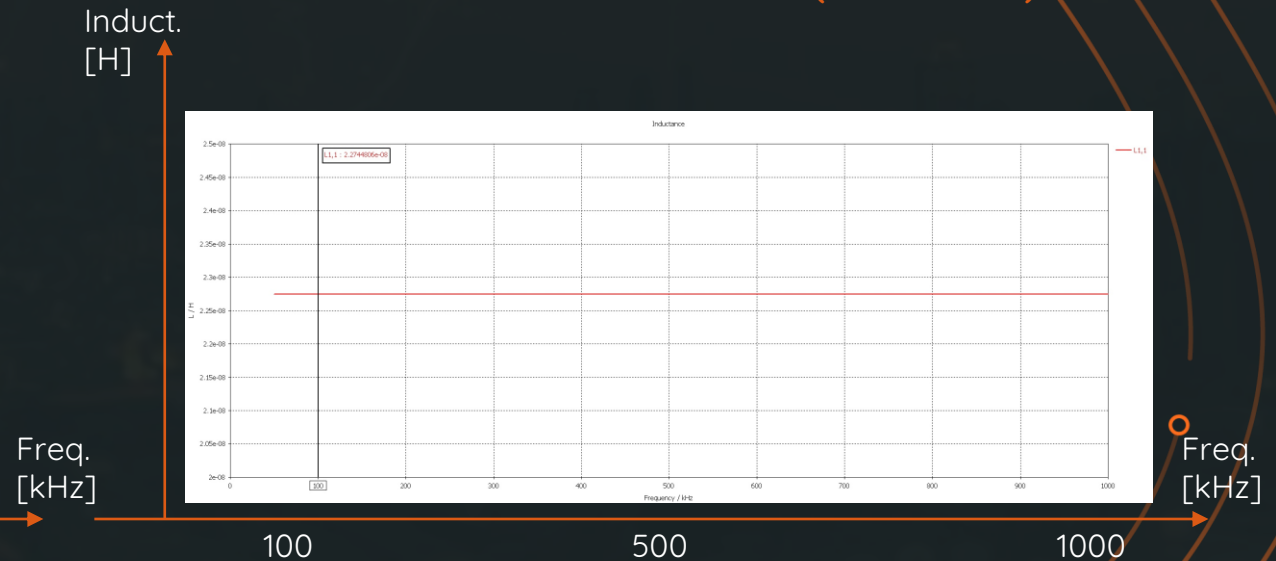


L4 = 42 nH
Measured 8 μH
(to be checked)

- Example for one AME-Coil L5

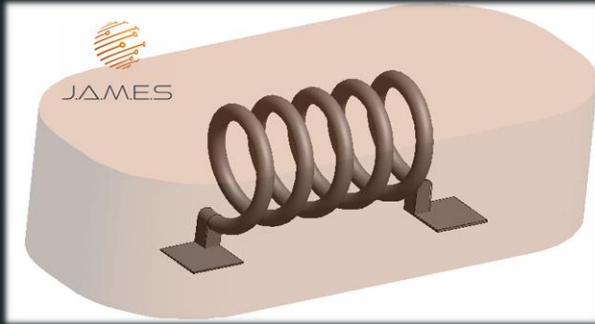


L5 = 23 nH
Measured 8 μH
(to be checked)

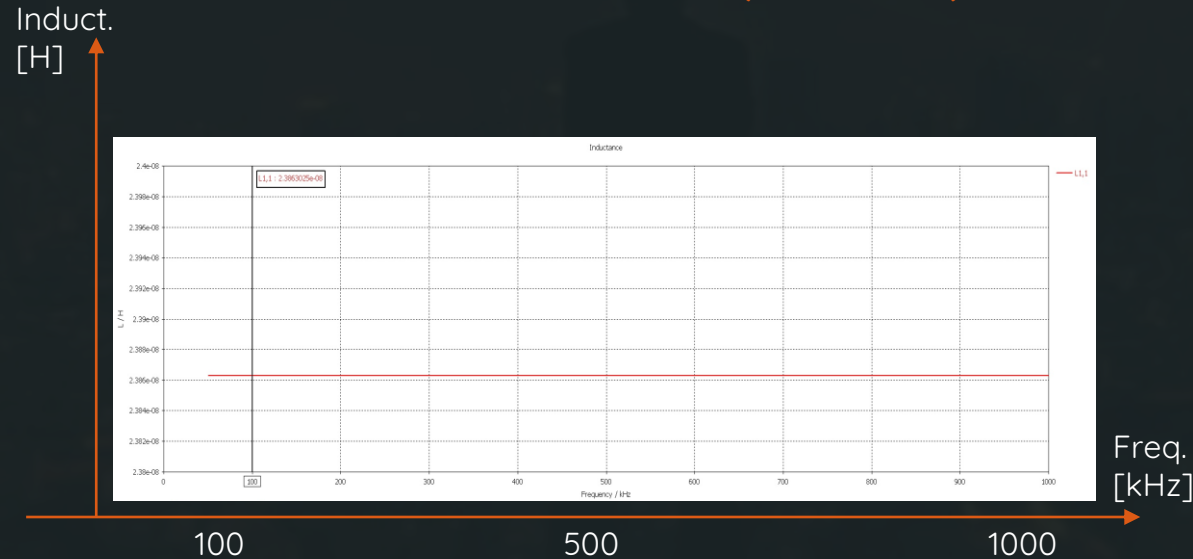


Coils and Caps single Coupon samples

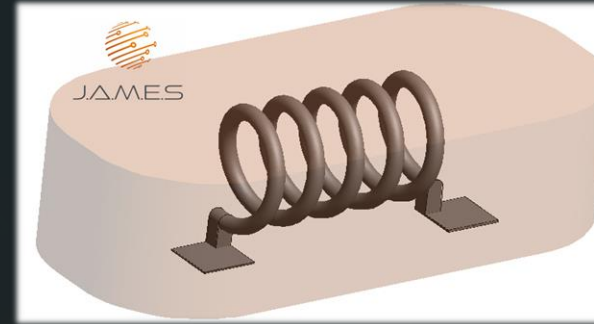
- Example for one AME-Coil L6



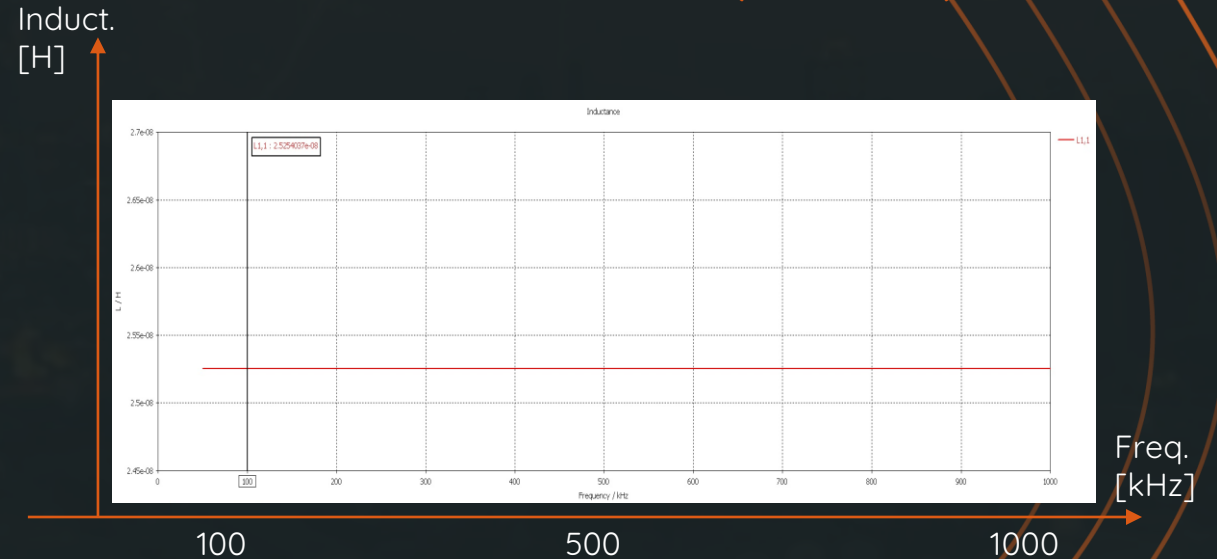
L6 = 23.9 nH
Measured 7 μ H
(to be checked)



- Example for one AME-Coil L7

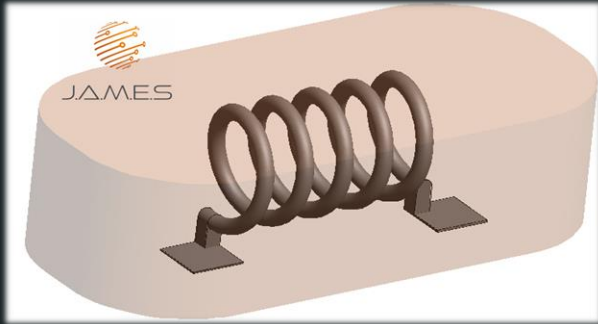


L7 = 25 nH
Measured 7 μ H
(to be checked)



Coils and Caps single Coupon samples

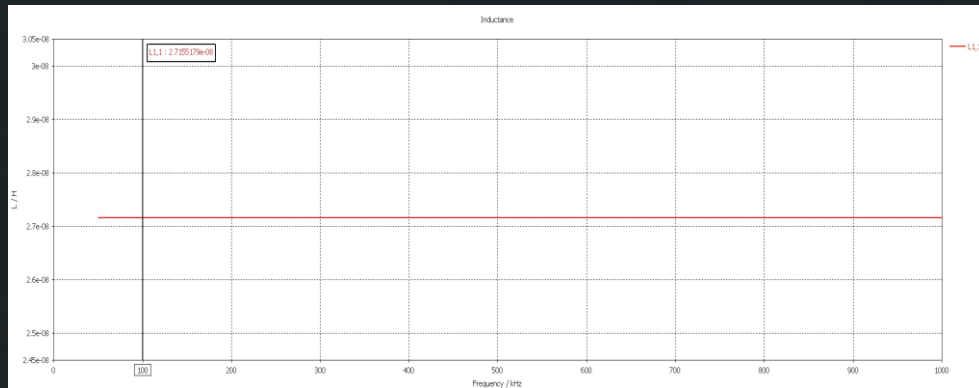
- Example for one AME-Coil L8



L7 = 27 nH

Measured 7 μ H
(to be checked)

Induct.
[H]



Freq.
[kHz]




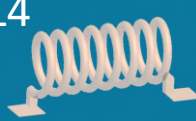
100


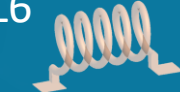
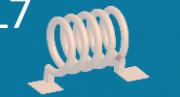
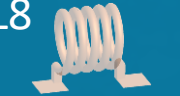
500






1000

Coils and Caps Coupon - Simulation

- Simulate 3D-Coil & Caps Design variations

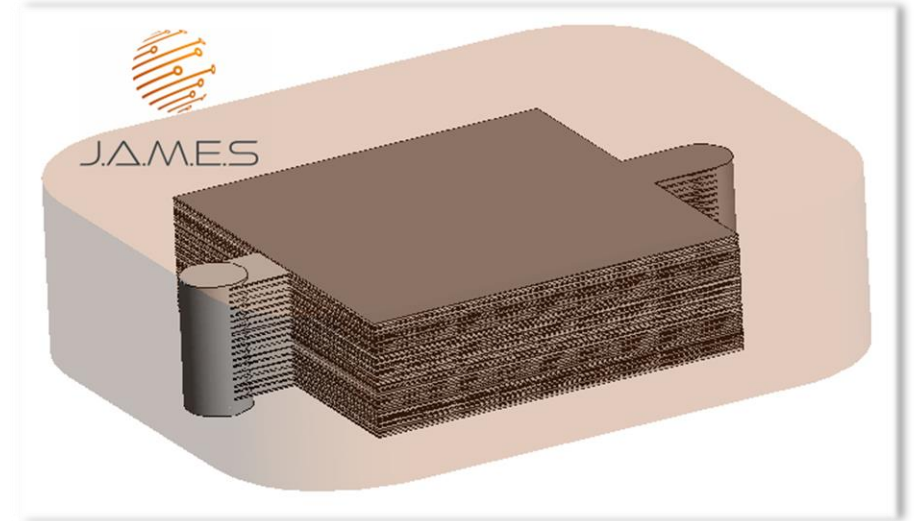
AME-Coil	Simulation @100 kHz
L1 	3.15 μ F
L2 	3.13 μ F
L3 	76 nH
L4 	42 nH

AME-Coil	Simulation
L5 	25 nH
L6 	23 nH
L7 	25 nH
L8 	27 nH

AME-Cap	DC-Simulation
C5 	171 pF
C4 	462 pF
C3 	299 pF
C2 	661 pF
C1 	1.35 nF

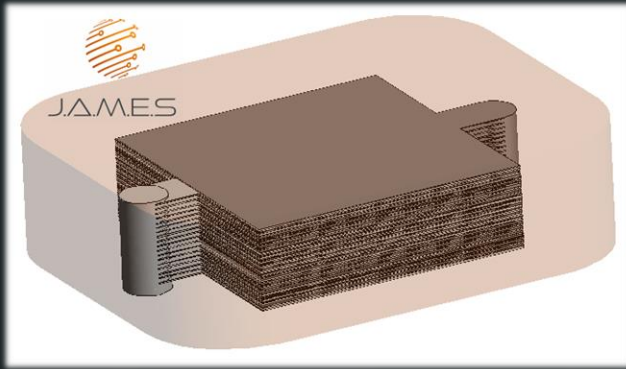
- Ongoing and additional investigations
 - Potential contribution activities by
 - Academia (e.g. Bachelor- / Master-Thesis)
 - Industry experts with AME-strategy

Comparison to Conventional COTS Elements



AME Capacitor and conventional COTS

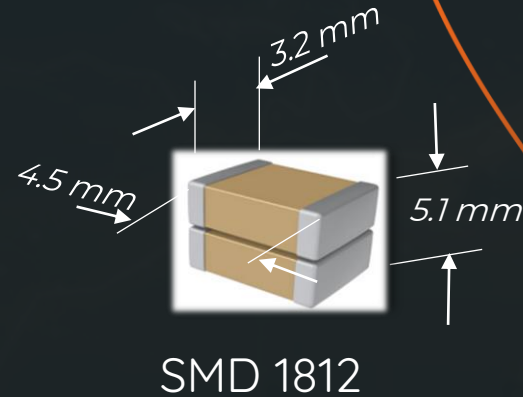
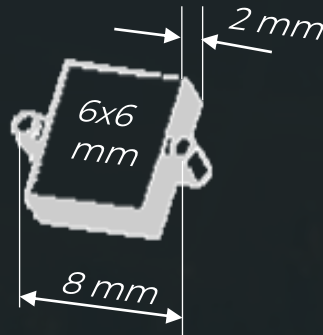
- By example AME Design C1 and custom of the shelf **1400 pF Multilayer Ceramic Capacitor MLCC by KEMET**
- Typical applications
 - Frequency converters, industrial and high-end power supplies, solar inverters
- What to take into account?



C1 ~ 1.42 nF @ 100 kHz

No further characterization available

SIMULATION characterization essential



Full characterization available

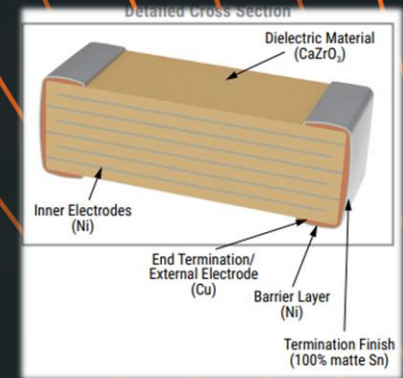
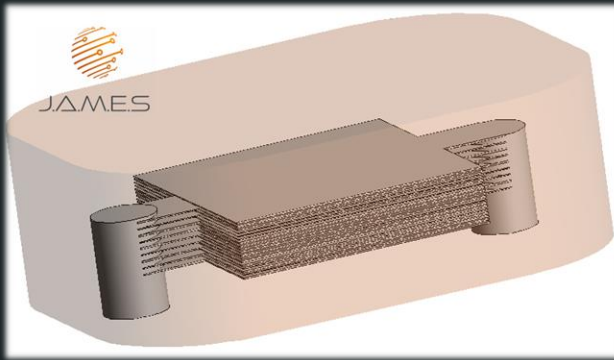


Table 1A - 1812 Product Ordering Codes, Ratings, and Package Quantities

KEMET Part Number ¹	Capacitance	Cap Code	Voltage	Number of Chips	Thickness mm (inch)	Typical Average Piece Weight (g)	Tape & Reel Quantity	
							7" Tape & Reel	13" Tape & Reel
C1812(a)142(b)ZGLC(c)	1.4 nF	142	2,500 V		5.1 (0.200) ±0.4 (0.016)	0.30	200	850

AME Capacitor and conventional COTS

- By example AME Design C5 and custom of the shelf **AC rated ceramic condenser 470 pF SMD** by Murata
- Typical applications
 - Switching power supplies, noise suppression filters etc.
- What to take into account?



C3 ~ 510 pF @ 100 kHz

No further characterization
available

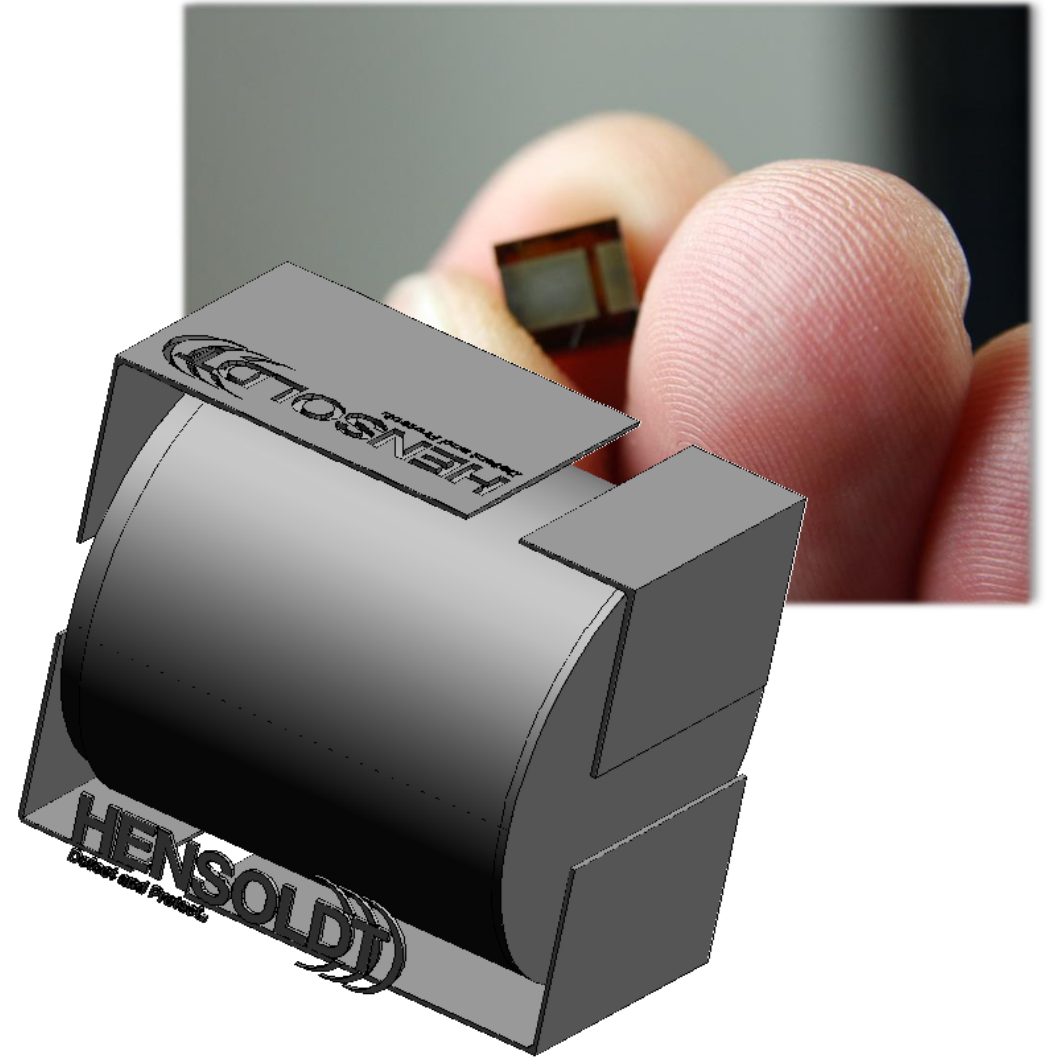


Full characterization available

Minimum quantity procurement 2000

SIMULATION characterization essential

Outlook



Outlook

- Further Designs for 3D AME-printed lumped elements will appear (e.g. for Filter building blocks)
- The ability to create freshaped passive lumed elements for
 - Individual formfactors
 - Miniaturised applications
 - Avoiding assembly
 - Technical reasons from DC to RFShow an upcoming trend and usecase for additively manufacturing electronics
- Sustainability reasons could play some relevant role
 - Needs-based Production of components in individual amounts can help to avoid production for waste
- Increase Effords to reach out a product level use case for 3D AME-printed elements
 - More characteristics data have to be provided
 - Simulation of AME-elements will play a major role for the future
 - The existing performance gap between simulation and realization results has to be bridged
 - In accordance to the overall AME long term stability issues



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